

C-Q4CI2Q56MX-P1M

Cisco® QDD-400-CU1M to Mellanox® MCP7H60-W001R30 Compatible TAA 400GBase-CU QSFP-DD 400G to 2xQSFP56 200G PAM-4 Direct Attach Cable (Passive Twinax, 1m)

Features:

- Compliant to QSFP-DD MSA Standards
- QSFP Module Compliant to SFF-8661
- Transmission Data Rate up to 56Gbps Per Channel
- Enables 400Gbps to 2x200Gbps Transmission
- Built-In EEPROM functions
- Hot-Pluggable
- Operating Temperature: 0 to 70 Celsius
- RoHS Compliant and Lead-Free



Applications:

- 400GBase Ethernet
- Switches, Servers, and Routers
- Data Center Networks
- Storage Area Networks
- Telecommunications and Wireless Infrastructure

Product Description

This Cisco® to Mellanox® dual oem compatible 400GBase-CU QSFP-DD to 2xQSFP56 passive direct attach cable has a maximum reach of 1.0m (3.3ft). It is 100% Cisco® to Mellanox® compatible and has been programmed, uniquely serialized, data-traffic and application tested to ensure that it is compliant and functional. This cable will initialize and perform identically to Cisco® and Mellanox®'s individual cables and is built to meet or exceed OEM specifications. This product complies with MSA (Multi-Source Agreement) standards and is TAA (Trade Acts Agreement) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

ProLabs' transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S. – made or designated country end products."



General Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit
Storage Temperature	Tstg	-40		85	°C
Operating Case Temperature	Tc	0		70	°C
Supply Voltage	Vcc	3.13	3.3	3.47	V
Relative Operating Humidity	RH	5		85	%
Data Rate	DR		400		Gbps

Physical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Length	L			1	M	
AWG			30		AWG	
Jacket Material		PVC, Black				

Electrical Specifications

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Resistance	Rcon			3	Ω	
Insulation Resistance	Rins			10	MΩ	
Raw Cable Impedance	Zca	95		110	Ω	
Mated Connector Impedance	Zmated	85		110	Ω	
Maximum Insertion Loss @13.28GHz	SDD21	8		17.16	dB	
Differential to Common-Mode Return Loss	SDD11/22	$RL_{cd}(f) \geq \begin{cases} 22 - (20/25.78)f & 0.01 \leq f < 12.89 \\ 15 - (6/25.78)f & 12.89 \leq f \leq 19 \end{cases}$			dB	
Differential to Common-Mode Conversion Loss	SCD21-SDD21	$Conversion_loss(f) - IL(f) \geq \begin{cases} 10 & 0.01 \leq f < 12.89 \\ 27 - (29/22)f & 12.89 \leq f \leq 15.7 \\ 6.3 & 15.7 \leq f \leq 19 \end{cases}$			dB	
Minimum COM	COM	3			dB	

Pin Descriptions For QSFP-DD

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1B	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3B	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3B	
4		GND	Module Ground.	1B	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3B	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3B	
7		GND	Module Ground.	1B	1
8	LVTTTL-I	ModSelL	Module Select.	3B	
9	LVTTTL-I	ResetL	Module Reset.	3B	
10		VccRx	+3.3V Receiver Power Supply.	2B	2
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock.	3B	
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	3B	
13		GND	Module Ground.	1B	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3B	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3B	
16		GND	Module Ground.	1B	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3B	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3B	
19		GND	Module Ground.	1B	1
20		GND	Module Ground.	1B	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3B	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3B	
23		GND	Module Ground.	1B	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3B	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3B	
26		GND	Module Ground.	1B	1
27	LVTTTL-O	ModPrsL	Module Present.	3B	
28	LVTTTL-O	IntL	Interrupt.	3B	
29		VccTx	+3.3V Transmitter Power Supply.	2B	2
30		Vcc1	+3.3V Power Supply.	2B	2
31	LVTTTL-I	InitMode	Initialization Mode. In legacy QSFP applications, the InitMode pad is called LPMODE.	3B	
32		GND	Module Ground.	1B	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3B	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3B	
35		GND	Module Ground.	1B	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3B	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3B	
38		GND	Module Ground.	1B	1
39		GND	Module Ground.	1A	1
40	CML-I	Tx6-	Transmitter Inverted Data Input.	3A	

41	CML-I	Tx6+	Transmitter Non-Inverted Data Input.	3A	
42		GND	Module Ground.	1A	1
43	CML-I	Tx8-	Transmitter Inverted Data Input.	3A	
44	CML-I	Tx8+	Transmitter Non-Inverted Data Input.	3A	
45		GND	Module Ground.	1A	1
46		Reserved	For Future Use.	3A	3
47		VS1	Module Vendor-Specific 1.	3A	3
48		VccRx1	+3.3V Receiver Power Supply.	2A	2
49		VS2	Module Vendor-Specific 2.	3A	3
50		VS3	Module Vendor-Specific 3.	3A	3
51		GND	Module Ground.	1A	1
52	CML-O	Rx7+	Receiver Non-Inverted Data Output.	3A	
53	CML-O	Rx7-	Receiver Inverted Data Output.	3A	
54		GND	Module Ground.	1A	1
55	CML-O	Rx5+	Receiver Non-Inverted Data Output.	3A	
56	CML-O	Rx5-	Receiver Inverted Data Output.	3A	
57		GND	Module Ground.	1A	1
58		GND	Module Ground.	1A	1
59	CML-O	Rx6-	Receiver Inverted Data Output.	3A	
60	CML-O	Rx6+	Receiver Non-Inverted Data Output.	3A	
61		GND	Module Ground.	1A	1
62	CML-O	Rx8-	Receiver Inverted Data Output.	3A	
63	CML-O	Rx8+	Receiver Non-Inverted Data Output.	3A	
64		GND	Module Ground.	1A	1
65		NC	Not Connected.	3A	3
66		Reserved	For Future Use.	3A	3
67		VccTx1	+3.3V Transmitter Power Supply.	2A	2
68		Vcc2	+3.3V Power Supply.	2A	2
69		Reserved	For Future Use.	3A	3
70		GND	Module Ground.	1A	1
71	CML-I	Tx7+	Transmitter Non-Inverted Data Input.	3A	
72	CML-I	Tx7-	Transmitter Inverted Data Input.	3A	
73		GND	Module Ground.	1A	1
74	CML-I	Tx5+	Transmitter Non-Inverted Data Input.	3A	
75	CML-I	Tx5-	Transmitter Inverted Data Input.	3A	
76		GND	Module Ground.	1A	1

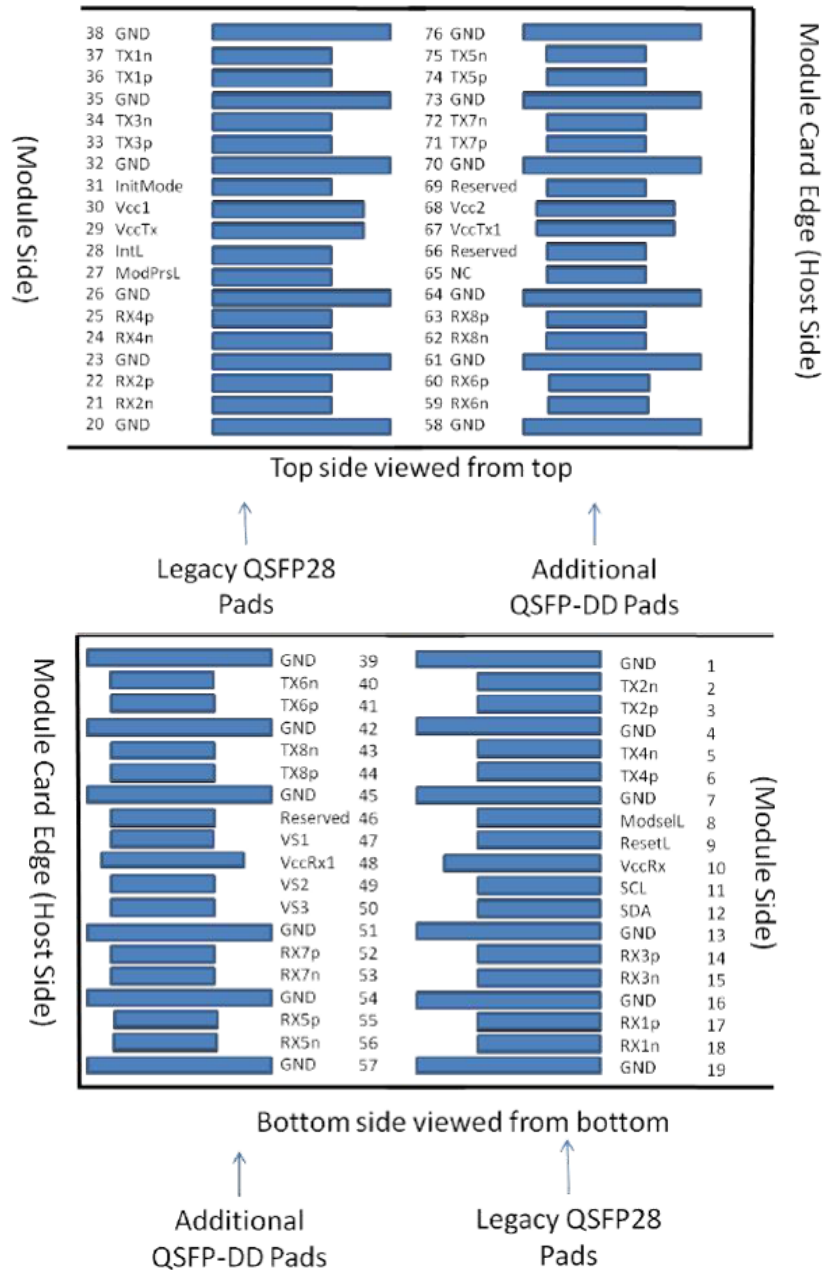
Notes:

1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 shall be applied concurrently. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 may be internally connected within the module in any combination. The connector Vcc

pins are each rated for a maximum current of 1000mA.

3. All Vendor-Specific, Reserved, and Not Connected pins may be terminated with 50Ω to ground on the host. Pad 65 (Not Connected) shall be left unconnected within the module. Vendor-Specific and Reserved pads shall have an impedance to GND that is greater than 10kΩ and less than 100pF.
4. Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1A, 2A, 3A, 1B, 2B, and 3B. Contact sequence A will make, then break contact with additional QSFP-DD pads. Sequence 1A, 1B will then occur simultaneously, followed by 2A, 2B, followed by 3A, 3B.

Electrical Pin-Out Details For QSFP-DD



Pin Descriptions for QSFP

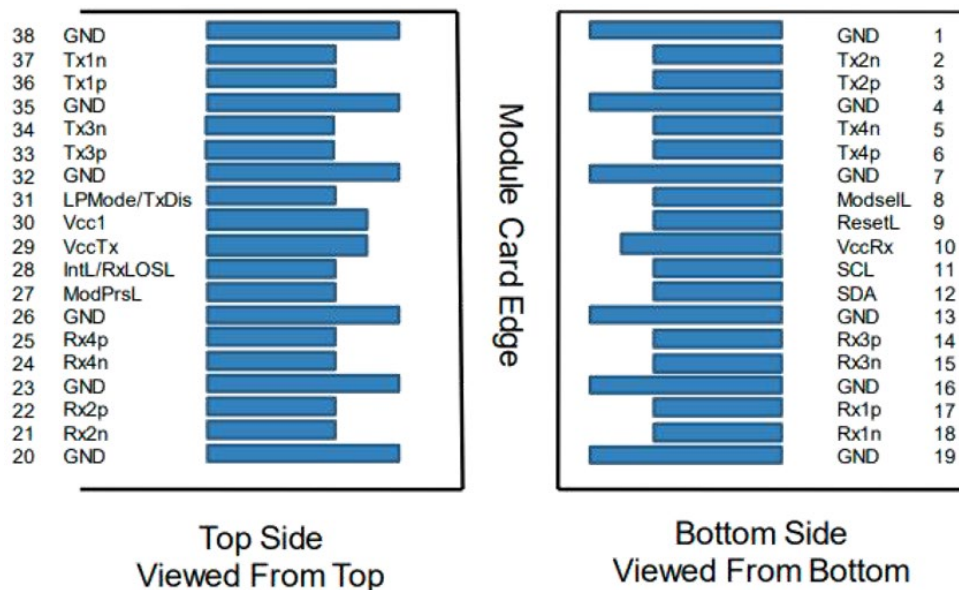
Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3	
4		GND	Module Ground.	1	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3	
7		GND	Module Ground.	1	1
8	LVTTL-I	ModSelL	Module Select.	3	
9	LVTTL-I	ResetL	Module Reset.	3	
10		VccRx	+3.3V Receiver Power Supply.	2	2
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock.	3	
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	3	
13		GND	Module Ground.	1	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3	
16		GND	Module Ground.	1	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3	
19		GND	Module Ground.	1	1
20		GND	Module Ground.	1	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3	
23		GND	Module Ground.	1	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3	
26		GND	Module Ground.	1	1
27	LVTTL-O	ModPrsL	Module Present.	3	
28	LVTTL-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636).	3	
29		VccTx	+3.3V Transmitter Power Supply.	2	2
30		Vcc1	+3.3V Power Supply.	2	2
31	LVTTL-I	LPMode/TxDis	Low-Power Mode. Optionally configurable as TxDis via the management interface (SFF-8636).	3	
32		GND	Module Ground.	1	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3	

34	CML-I	Tx3-	Transmitter Inverted Data Input.	3	
35		GND	Module Ground.	1	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3	
38		GND	Module Ground.	1	1

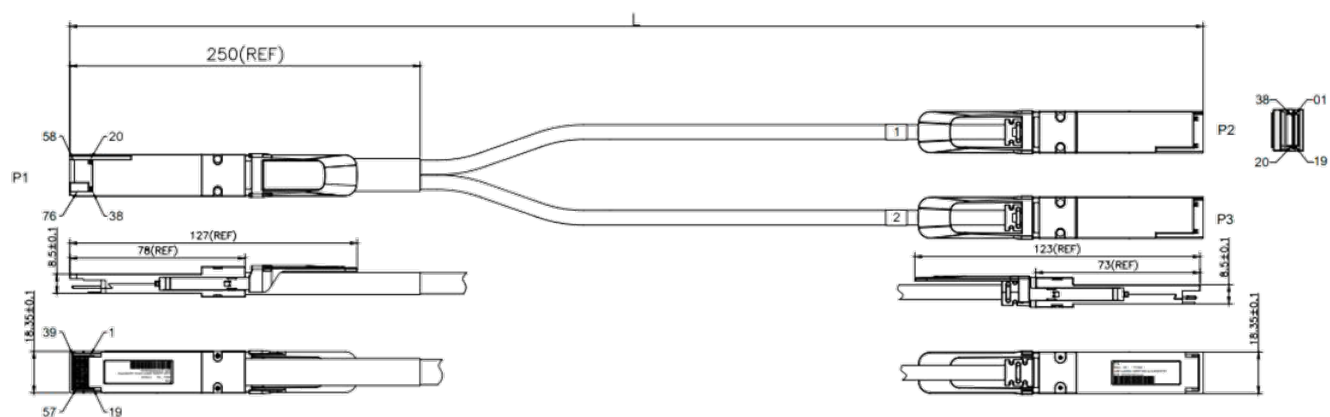
Notes:

1. GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, Vcc1, and VccTx are the receiver and transmitter power supplies and shall be applied concurrently. VccRx, Vcc1, and VccTx may be internally connected within the QSFP transceiver module in any combination. The connector pins are each rated for a maximum current of 500mA.

Electrical Pin-Out Details for QSFP



Mechanical Specifications



About ProLabs

Our experience comes as standard; for over 15 years ProLabs has delivered optical connectivity solutions that give our customers freedom and choice through our ability to provide seamless interoperability. At the heart of our company is the ability to provide state-of-the-art optical transport and connectivity solutions that are compatible with over 90 optical switching and transport platforms.

Complete Portfolio of Network Solutions

ProLabs is focused on innovations in optical transport and connectivity. The combination of our knowledge of optics and networking equipment enables ProLabs to be your single source for optical transport and connectivity solutions from 100Mb to 400G while providing innovative solutions that increase network efficiency. We provide the optical connectivity expertise that is compatible with and enhances your switching and transport equipment.

Trusted Partner

Customer service is our number one value. ProLabs has invested in people, labs and manufacturing capacity to ensure that you get immediate answers to your questions and compatible product when needed. With Engineering and Manufacturing offices in the U.K. and U.S. augmented by field offices throughout the U.S., U.K. and Asia, ProLabs is able to be our customers best advocate 24 hours a day.



Contact Information

ProLabs US

Email: sales@prolabs.com

Telephone: 952-852-0252

ProLabs UK

Email: salesupport@prolabs.com

Telephone: +44 1285 719 600